May 2000
Revised December 2005

NC7WB3306
2-Bit Low Power Bus Switch

General Description

The NC7WB3306 is a 2-bit ultra high-speed CMOS FET bus switch with TTL-compatible active LOW control inputs. The low On Resistance of the switch allows inputs to be connected to outputs with minimal propagation delay and without generating additional ground bounce noise. The device is organized as a 2-bit switch with independent bus enable ($\overline{OE}$) controls. When $\overline{OE}$ is LOW, the switch is ON and Port A is connected to Port B. When $\overline{OE}$ is HIGH, the switch is OPEN and a high-impedance state exists between the two ports. Control inputs tolerate voltages up to 5.5V independent of V_{CC}.

Features

- Space saving US8 surface mount package
- MicroPak™ Pb-Free leadless package
- Typical 3Ω switch resistance at 5.0V V_{CC}
- Minimal propagation delay through the switch
- Power down high impedance input/output
- Zero bounce in flow through mode.
- TTL compatible active LOW control inputs
- Control inputs are overvoltage tolerant

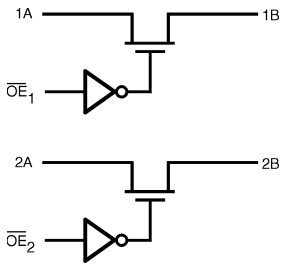
Ordering Code:

Order Number	Package Number	Product Code Top Mark	Package Description	Supplied As
NC7WB3306K8X	MAB08A	WB06	8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide	3k Units on Tape and Reel
NC7WB3306L8X	MAC08A	U3	Pb-Free 8-Lead MicroPak, 1.6 mm Wide	5k Units on Tape and Reel

Pb-Free package per JEDEC J-STD-020B.

MicroPak™ is a trademark of Fairchild Semiconductor Corporation.

Logic Symbol



Pin Descriptions

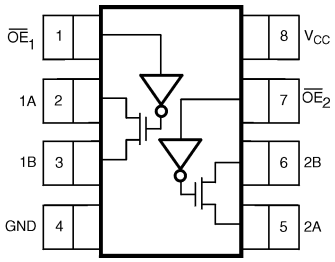
Pin Name	Description
A	Bus A
B	Bus B
$\overline{OE}$	Bus Enable Input

Function Table

Bus Enable Input $\overline{OE}$	Function
L	B Connected to A
H	Disconnected

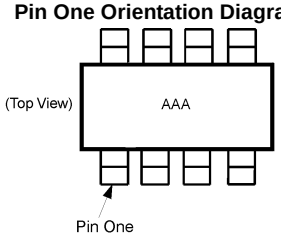
H = HIGH Logic Level
L = LOW Logic Level

Connection Diagrams



(Top View)

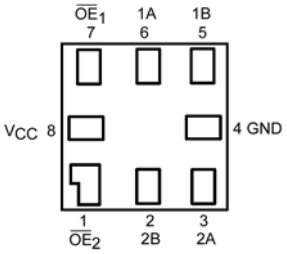
Pin One Orientation Diagram



AAA represents Product Code Top Mark - see ordering code

Note: Orientation of Top Mark determines Pin One location. Read the top product code mark left to right, Pin One is the lower left pin (see diagram).

Pad Assignments for MicroPak



(Top Through View)

Absolute Maximum Ratings (Note 1)

Supply Voltage (V_{CC})	−0.5V to +7.0V
DC Switch Voltage (VS)	−0.5V to +7.0V
DC Output Voltage (V_{IN}) (Note 2)	−0.5V to +7.0V
DC Input Diode Current	
(I_{IK}) V_{IN} < 0V	−50 mA
DC Output (I_{OUT}) Current	128 mA
DC V_{CC} or Ground Current (I_{CC}/GND)	±100 mA
Storage Temperature Range (T_{STG})	−65°C to +150°C
Junction Lead Temperature under Bias (T_J)	+150°C
Lead Temperature (T_L)	
(Soldering, 10 seconds)	+260°C
Power Dissipation (P_D) @ +85°C	250 mW

Recommended Operating Conditions (Note 3)

Supply Operating (V_{CC})	4.0V to 5.5V
Control Input Voltage (V_{IN})	0V to 5.5V
Switch Input Voltage (V_{IN})	0V to 5.5V
Output Voltage (V_{OUT})	0V to 5.5V
Operating Temperature (T_A)	−40°C to +85°C
Input Rise and Fall Time (t_r, t_f)	
Control Input	0 ns/V to 5 ns/V
Switch I/O	0 ns/V to DC
Thermal Resistance (θ_{JA})	250°C/W

Note 1: The "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The "Recommended Operating Conditions" table will define the conditions for actual device operation.

Note 2: The input and output negative voltage ratings may be exceeded if the input and output diode current ratings are observed.

Note 3: Unused logic inputs must be held HIGH or LOW. They may not float.

DC Electrical Characteristics

Symbol	Parameter	V_{CC}	T_A = −40°C to +85°C			Units	Conditions
		(V)	Min	Typ	Max		
V_{IK}	Clamp Diode Voltage	4.5			−1.2	V	I_{IN} = −18 mA
V_{IH}	HIGH Level Input Voltage	4.0 to 5.5	2.0			V	
V_{IL}	LOW Level Input Voltage	4.0 to 5.5			0.8	V	
V_{OH}	HIGH Level Output Voltage	4.5 to 5.5	see Figure 3			V	V_{IN} = V_{CC}
I_{IN}	Input Leakage Current	5.5			±1.0	μA	0 ≤ V_{IN} ≤ 5.5V
I_{OFF}	Switch OFF Leakage Current	5.5			±1.0	μA	0 ≤ A, B, ≤ V_{CC}
R_{ON}	Switch On Resistance (Note 4)	4.5		3.0	7.0	Ω	V_{IN} = 0V, I_{IN} = 64 mA
		4.5		3.0	7.0		V_{IN} = 0V, I_{IN} = 30 mA
		4.5		6.0	15.0		V_{IN} = 2.4V, I_{IN} = 15 mA
		4.0		10.0	20.0		V_{IN} = 2.4V, I_{IN} = 15 mA
I_{CC}	Quiescent Supply Current	5.5			3.0	μA	V_{IN} = V_{CC} or GND, I_{OUT} = 0
ΔI_{CC}	Increase in I_{CC} per Input (Note 5)	5.5		1.0	2.5	mA	V_{IN} = 3.4V, I_O = 0, Control Input Only

Note 4: Measured by the voltage drop between A and B pins at the indicated current through the switch. On Resistance is determined by the lower of the voltages on the two (A or B) pins.

Note 5: Per TTL driven input (V_{IN} = 3.4V, control input only). A and B pins do not contribute to I_{CC}.

AC Electrical Characteristics

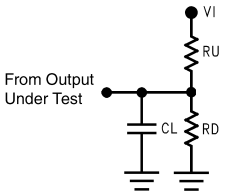
Symbol	Parameter	V_{CC} (V)	$T_A = -40°C$ to $+85°C$, $C_L = 50$ pF, RU = RD = 500Ω			Units	Conditions	Figure Number
			Min	Typ	Max			
t_{PHL}, t_{PLH}	Propagation Delay Bus-to-Bus (Note 6)	4.0 to 5.5			0.25	ns	V_I = OPEN	Figures 1, 2
t_{PZL}, t_{PZH}	Output Enable Time	4.5 to 5.5	0.8	2.5	4.2	ns	V_I = 7V for t_{PZL} V_I = 0V for t_{PZH}	Figures 1, 2
		4.0	0.8	3.0	4.6			
t_{PLZ}, t_{PHZ}	Output Disable Time	4.5 to 5.5	0.8	3.1	4.8	ns	V_I = 7V for t_{PLZ} V_I = 0V for t_{PHZ}	Figures 1Figure 2
		4.0	0.8	2.9	4.4			

Note 6: This parameter is guaranteed. The bus switch contributes no propagation delay other than the RC delay of the typical On Resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance). The specified limit is calculated on this basis.

Capacitance

Symbol	Parameter	Typ	Max	Units	Conditions
C_{IN}	Control Pin Input Capacitance	2.5		pF	V_{CC} = 0V
$C_{I/O}$ (OFF)	Port OFF Capacitance	6.0		pF	V_{CC} = 5.0V = $\overline{OE}$
$C_{I/O}$ (ON)	Switch ON Capacitance	12.0		pF	V_{CC} = 5.0V, $\overline{OE}$ = 0V

AC Loading and Waveforms



Input driven by 50Ω source terminated in 50Ω.

C_L includes load and stray capacitance.

Input PRR = 1.0 MHz t_w = 500 ns.

FIGURE 1. AC Test Circuit

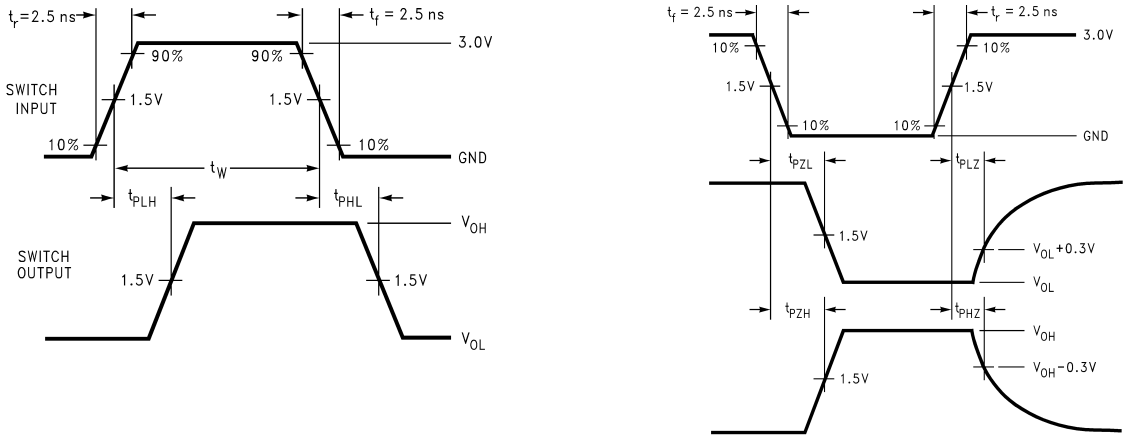
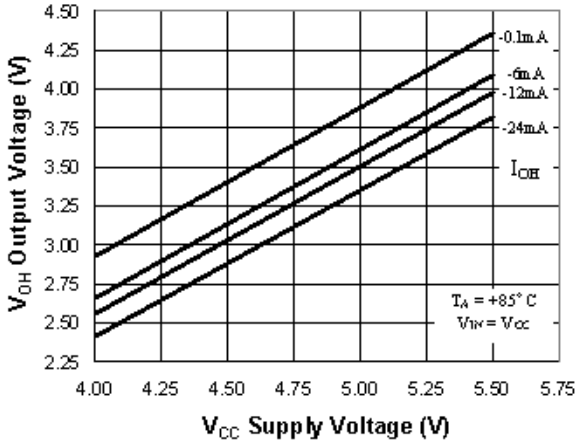
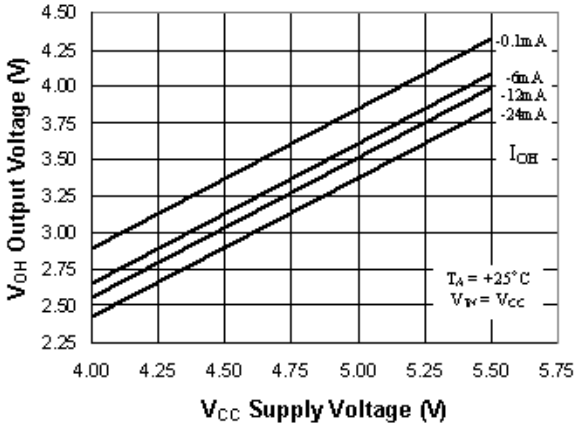


FIGURE 2. AC Waveforms

DC Characteristics





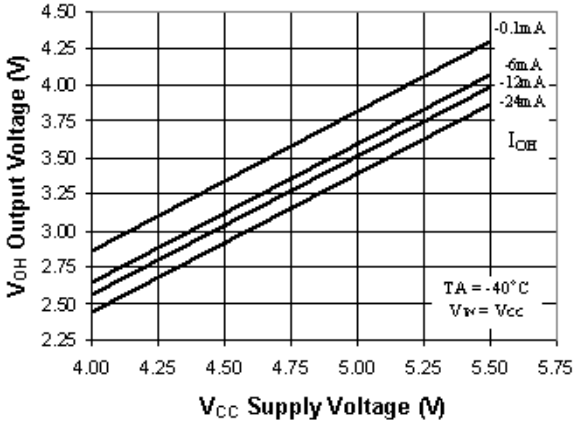


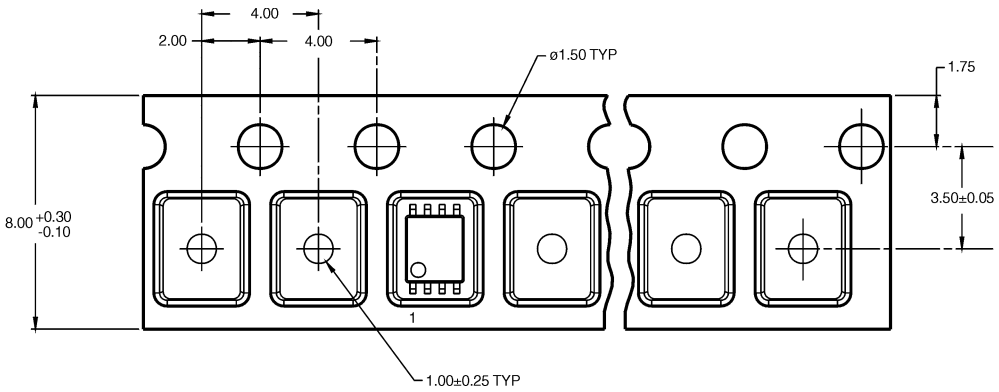
FIGURE 3. Typical High Level Output Voltage vs. Supply Voltage

Tape and Reel Specification

TAPE FORMAT for US8

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
K8X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	250	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

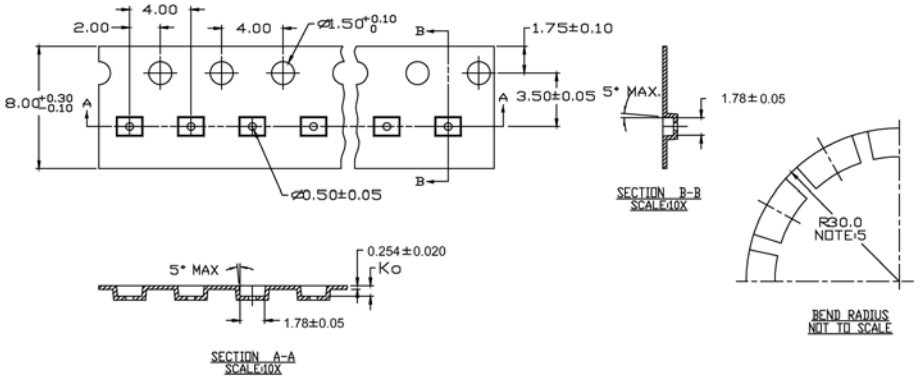
TAPE DIMENSIONS inches (millimeters)



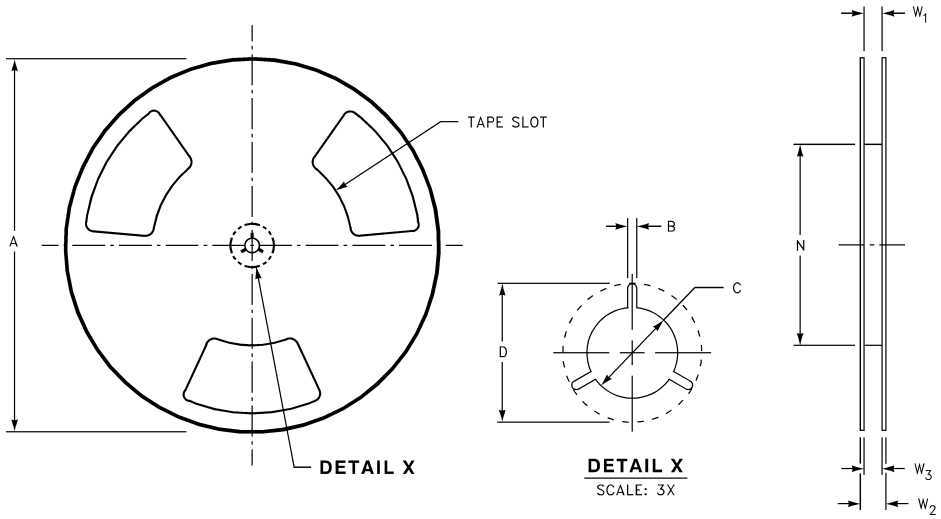
TAPE FORMAT for MicroPak

Package Designator	Tape Section	Number Cavities	Cavity Status	Cover Tape Status
L8X	Leader (Start End)	125 (typ)	Empty	Sealed
	Carrier	250	Filled	Sealed
	Trailer (Hub End)	75 (typ)	Empty	Sealed

TAPE DIMENSIONS inches (millimeters)

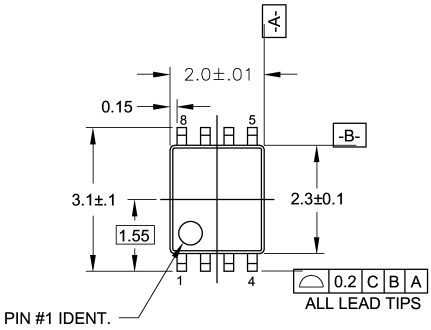


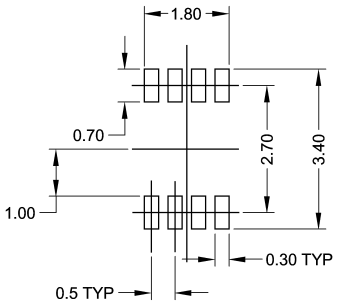
REEL DIMENSIONS inches (millimeters)



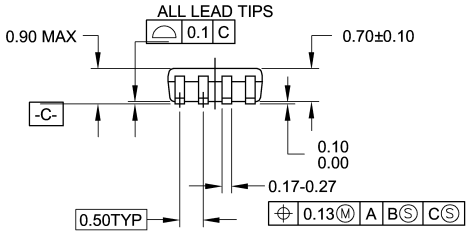
Tape Size	A	B	C	D	N	W1	W2	W3
8 mm	7.0 (177.8)	0.059 (1.50)	0.512 (13.00)	0.795 (20.20)	2.165 (55.00)	0.331 + 0.059/–0.000 (8.40 + 1.50/–0.00)	0.567 (14.40)	W1 + 0.078/–0.039 (W1 + 2.00/–1.00)

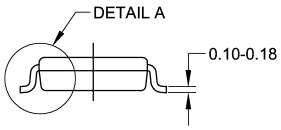
Physical Dimensions inches (millimeters) unless otherwise noted

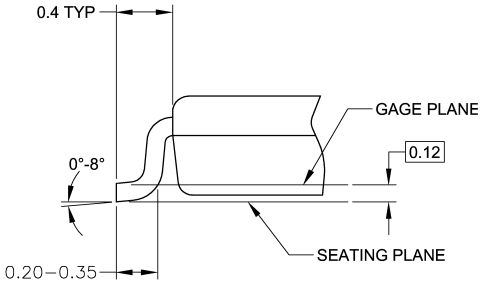




LAND PATTERN RECOMMENDATION







DETAIL A

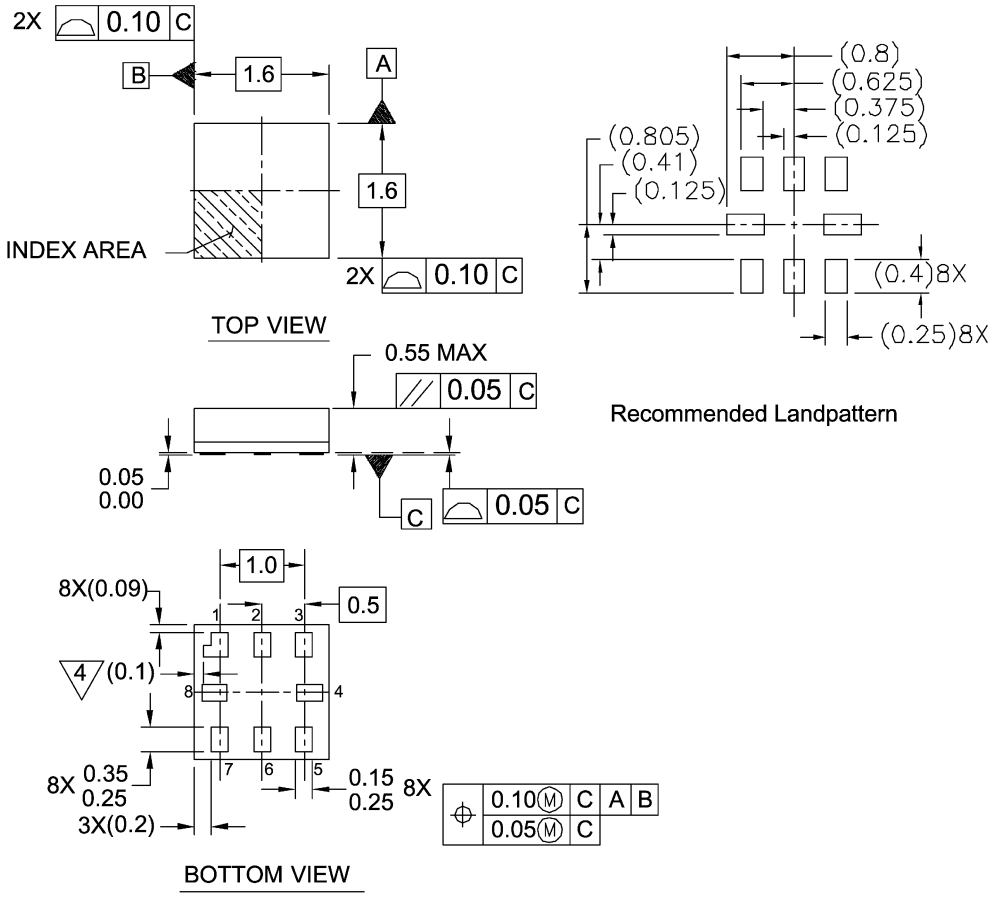
NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-187
B. DIMENSIONS ARE IN MILLIMETERS.
C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MAB08AREVC

8-Lead US8, JEDEC MO-187, Variation CA 3.1mm Wide
Package Number MAB08A

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



Notes:

1. PACKAGE CONFORMS TO JEDEC MO-255 VARIATION UAAD
2. DIMENSIONS ARE IN MILLIMETERS
3. DRAWING CONFORMS TO ASME Y.14M-1994

4 PIN 1 FLAG, END OF PACKAGE OFFSET.

MAC08AREVC

Pb-Free 8-Lead MicroPak, 1.6 mm Wide
Package Number MAC08A

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of terms

Datasheet Identification	Product Status	Definition
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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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